

Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

 Series/Type:
 B32774 ... B32778

 Date:
 December 2012

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MKP DC link - high density series

Typical applications

For compact design of:

- Frequency converters
- Industrial and high-end power supplies
- Solar inverters

Climatic

- Max. operating temperature: 105 °C (case)
- Climatic category (IEC 60068-1): 40/85/56

Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Capacitance values up to 110 μF
- High CV product, compact
- Excellent self-healing properties
- Overvoltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

Terminals

- Parallel wire leads, lead-free tinned
- 2-pin and 4-pin versions
- Standard lead lengths: 6 -1 mm
- Special lead lengths are available on request

Marking

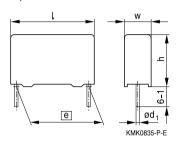
Manufacturer's logo, lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage

Delivery mode

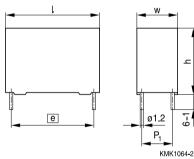
Bulk (untaped, lead length 6-1 mm)

Dimensional drawings

2-pin version



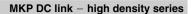
4-pin version



Dimensions in mm

Version	Lead spacing e ±0.4	Lead diameter d ₁	Туре
2-pin	27.5	0.8	B32774D
2-pin	37.5	1.0	B32776E/T
4-pin	37.5	1.2	B32776G
4-pin	52.5	1.2	B32778G







Overview of available types

Lead spacing	27.5 m	ım			37.5 m	m				
Туре	B3277	4			B32770	6				
Page	5				6					
V _R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
C _R (μF)										
1.5										
2.0										
2.7										
3.0										
3.5										
3.9										
5.0										
6.8										
7.0										
7.5										
8.0										
8.5										
10										
12										
14										
15										
16										
20										
22										
25										
30										
35										
40										
45										
50										
55										
60										





Lead spacing	52 5 mm								
Type	B32778								
Page	9								
V _R (V DC)	450	575	800	900	1100	1300			
C _R (μF)									
20									
25									
27									
30									
35									
40									
45									
50									
55									
60									
75									
80									
100									
110									



MKP DC link - high density series



Ordering codes and packing units (lead spacing 27.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Untaped
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	
			below)	10 kHz	20 kHz	10 kHz	
μF	mm	mm		Α	Α	mΩ	pcs./MOQ
V _{R,70} ° _C	= 450 V DC, V _{op,85} ° _C	₀ = 4	50 V DC				
5.0	$11.0 \times 21.0 \times 31.5$	_	B32774D4505+000	5.0	4.5	8.5	2352
10	$15.0 \times 24.5 \times 31.5$	_	B32774D4106+000	6.5	6.0	7.5	1680
22	$22.0 \times 36.5 \times 31.5$	_	B32774D4226+000	10.0	9.0	5.0	784
$V_{R,70^{\circ}C}$	= 800 V DC, V _{op,85} °C	c = 7	00 V DC				
3.0	$11.0 \times 21.0 \times 31.5$	_	B32774D8305+000	5.0	4.5	9.0	2352
5.0	$14.0 \times 24.5 \times 31.5$	_	B32774D8505+000	5.0	4.5	7.0	1848
12	$22.0\times36.5\times31.5$	_	B32774D8126+000	6.0	5.5	6.5	784
V _{R,70} °C	= 1100 V DC, V _{op,85} °c	= 9	20 V DC				
2.0	$12.5 \times 21.5 \times 31.5$	_	B32774D0205+000	4.0	3.5	11.0	2100
5.0	$19.0 \times 30.0 \times 31.5$	_	B32774D0505+000	6.5	6.0	7.0	896
7.0	$22.0\times36.5\times31.5$	_	B32774D0705+000	7.5	7.0	5.5	784
V _{R,70} °C	V _{R,70} °C = 1300 V DC, V _{op,85} °C = 1100 V DC						
1.5	$12.5 \times 21.5 \times 31.5$	_	B32774D1155+000	4.5	4.0	10.5	2100
3.0	$18.0 \times 27.5 \times 31.5$	_	B32774D1305+000	6.0	5.5	7.0	1428
5.0	$22.0\times36.5\times31.5$	_	B32774D1505+000	8.0	7.0	6.0	784

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = +10%





MKP DC link - high density series

Ordering codes and packing units (lead spacing 37.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS.max}	I _{RMS,max}	ESR _{typ}	Untaped
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	
			below)	10 kHz	20 kHz	10 kHz	
μF	mm	mm	,	Α	Α	mΩ	pcs./MOQ
V _{R,70} ° _C	= 450 V DC, V _{op,85} °c	₀ = 45	0 V DC				
12	$24.0 \times 15.0 \times 41.5$	_	B32776T4126K000	8.0	8.0	8.0	1040
16	$24.0 \times 19.0 \times 41.5$	_	B32776T4166K000	9.0	9.0	7.0	780
30	$20.0\times39.5\times41.5$	10.2	B32776G4306+000	12.5	11.5	8.0	640
30	$20.0 \times 39.5 \times 41.5$	_	B32776E4306+000	11.5	10.5	9.0	640
35	$28.0\times37.0\times42.0$	10.2	B32776G4356+000	13.5	12.5	8.0	440
35	$28.0 \times 37.0 \times 42.0$	_	B32776E4356+000	12.5	11.5	9.0	440
40	$28.0 \times 37.0 \times 42.0$	10.2	B32776G4406+000	14.5	13.5	5.0	440
40	$28.0 \times 37.0 \times 42.0$	_	B32776E4406+000	13.5	12.5	5.5	440
50	$28.0\times42.5\times41.5$	10.2	B32776G4506+000	16.0	15.0	4.0	440
50	$28.0\times42.5\times41.5$	_	B32776E4506+000	15.0	14.0	4.0	440
60	$30.0\times45.0\times42.0$	_	B32776E4606+000	16.5	15.0	3.0	400
V _{R,70} ° _C	= 575 V DC, V _{op,85} °c	₀ = 50	0 V DC				
8.5	$24.0 \times 15.0 \times 41.5$	_	B32776T5855+000	8.5	8.5	7.0	1040
12	$24.0 \times 19.0 \times 41.5$	_	B32776T5126K000	9.0	9.0	7.0	780
25	$20.0 \times 39.5 \times 41.5$	10.2	B32776G5256K000	11.5	11.5	4.75	640
25	$20.0\times39.5\times41.5$	_	B32776E5256K000	11.0	11.0	5.0	640
30	$28.0\times37.0\times42.0$	10.2	B32776G5306+000	14.0	14.0	3.85	440
30	$28.0 \times 37.0 \times 42.0$	_	B32776E5306+000	13.5	13.5	4.0	440
35	$28.0\times42.5\times41.5$	10.2	B32776G5356+000	14.5	14.0	3.75	440
35	$28.0 \times 42.5 \times 41.5$	_	B32776E5356+000	14.0	13.5	4.0	440
45	$30.0\times45.0\times42.0$	20.3	B32776G5456K000	16.5	16.5	2.85	400
45	$30.0\times45.0\times42.0$	_	B32776E5456K000	15.5	15.0	3.4	400
55	$33.0\times48.0\times42.0$	20.3	B32776G5556K000	19.0	19.0	2.4	180

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K=\pm 10\%$



MKP DC link - high density series



Ordering codes and packing units (lead spacing 37.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Untaped
	$w \times h \times I$		(composition see	70 °C	70 °C	70 °C	
			below)	10 kHz	20 kHz	10 kHz	
μF	mm	mm		Α	Α	mΩ	pcs./MOQ
$V_{R,70^{\circ}C} = 800 \text{ V DC}, V_{op,85^{\circ}C} = 700 \text{ V DC}$							
6.8	$24.0 \times 15.0 \times 41.5$	-	B32776T8685+000	7.0	7.0	11.0	1040
8.5	$24.0 \times 19.0 \times 41.5$	_	B32776T8855+000	8.0	8.0	9.0	780
14	$18.0 \times 32.5 \times 41.5$	_	B32776E8146+000	10.0	9.0	7.5	720
15	$20.0 \times 39.5 \times 41.5$	10.2	B32776G8156+000	10.5	9.5	7.0	640
20	$28.0 \times 37.0 \times 42.0$	10.2	B32776G8206+000	12.0	11.0	5.5	440
20	$28.0 \times 37.0 \times 42.0$	_	B32776E8206+000	11.5	10.5	6.5	440
22	$28.0 \times 37.0 \times 42.0$	10.2	B32776G8226+000	13.0	12.0	5.0	440
25	$28.0 \times 42.5 \times 41.5$	_	B32776E8256+000	13.5	12.5	4.5	440
30	$30.0 \times 45.0 \times 42.0$	20.3	B32776G8306+000	15.0	14.0	3.5	400
30	$30.0 \times 45.0 \times 42.0$	_	B32776E8306+000	14.0	13.0	5.0	400
V _{R,70} ° _C	= 900 V DC, V _{op,85} °c	c = 80	0 V DC				
5	$24.0 \times 15.0 \times 41.5$	_	B32776T9505+000	4.5	4.5	17.0	1040
7.5	$24.0 \times 19.0 \times 41.5$	_	B32776T9755K000	6.0	6.0	12.0	780
15	$20.0 \times 39.5 \times 41.5$	10.2	B32776G9156K000	10.5	10.5	6.15	640
15	$20.0 \times 39.5 \times 41.5$	_	B32776E9156K000	10.0	10.0	6.35	640
20	$28.0 \times 37.0 \times 42.0$	10.2	B32776G9206K000	12.5	12.5	4.7	440
20	$28.0 \times 37.0 \times 42.0$	_	B32776E9206K000	12.0	12.0	4.9	440
22	$28.0 \times 42.5 \times 41.5$	10.2	B32776G9226K000	13.0	13.0	4.3	440
22	$28.0 \times 42.5 \times 41.5$	_	B32776E9226K000	12.5	12.0	4.8	440
25	$30.0 \times 45.0 \times 42.0$	20.3	B32776G9256+000	15.0	14.5	3.8	400
25	$30.0\times45.0\times42.0$	_	B32776E9256+000	14.0	13.5	4.2	400
30	$33.0\times48.0\times42.0$	20.3	B32776G9306+000	17.0	16.5	2.85	180

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MKP DC link - high density series

Ordering codes and packing units (lead spacing 37.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Untaped
	$w \times h \times I$		(composition see	70 °C	70 °C	70 °C	
			below)	10 kHz	20 kHz	10 kHz	
μF	mm	mm		Α	Α	mΩ	pcs./MOQ
V _{R,70} ° _C	= 1100 V DC, $V_{op,85}$ °c	₀ = 92					
3.9	$24.0 \times 15.0 \times 41.5$	-	B32776T0395+000	6.5	6.5	12.0	1040
5	$24.0 \times 19.0 \times 41.5$	_	B32776T0505+000	7.0	7.0	10.0	780
12	$20.0\times39.5\times41.5$	10.2	B32776G0126+000	11.0	10.0	6.5	640
12	$20.0 \times 39.5 \times 41.5$	_	B32776E0126+000	10.0	9.0	7.0	640
14	$28.0 \times 37.0 \times 42.0$	10.2	B32776G0146+000	13.0	12.0	5.5	440
14	$28.0 \times 37.0 \times 42.0$	_	B32776E0146+000	12.0	11.0	6.0	440
16	$28.0 \times 42.5 \times 41.5$	10.2	B32776G0166+000	13.0	12.0	5.0	440
16	$28.0 \times 42.5 \times 41.5$	_	B32776E0166+000	12.0	11.0	5.5	440
20	$30.0 \times 45.0 \times 42.0$	20.3	B32776G0206+000	15.0	13.0	3.0	400
20	$30.0\times45.0\times42.0$	_	B32776E0206+000	13.0	12.0	3.5	400
V _{R,70} ° _C	= 1300 V DC, $V_{op,85}$ °c	c = 110	0 V DC				
2.7	$24.0 \times 15.0 \times 41.5$	_	B32776T1275+000	6.0	6.0	16.0	1040
3.5	$24.0 \times 19.0 \times 41.5$	_	B32776T1355+000	6.5	6.5	13.0	780
8.0	$20.0 \times 39.5 \times 41.5$	10.2	B32776G1805+000	9.0	8.0	8.0	640
10	$28.0 \times 37.0 \times 42.0$	10.2	B32776G1106+000	12.0	11.0	6.5	440
10	$28.0 \times 37.0 \times 42.0$	_	B32776E1106+000	11.0	10.0	7.0	440
12	$28.0 \times 42.5 \times 41.5$	10.2	B32776G1126+000	13.0	12.0	5.5	440
14	$30.0\times45.0\times42.0$	_	B32776E1146+000	13.0	12.0	5.0	400

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$



MKP DC link - high density series



Ordering codes and packing units (lead spacing 52.5 mm)

C _R	Max. dimensions	P ₁	Ordering code	I _{RMS,max}	I _{RMS,max}	ESR _{typ}	Untaped
	$w \times h \times l$		(composition see	70 °C	70 °C	70 °C	
			below)	10 kHz	20 kHz	10 kHz	
μF	mm	mm		Α	Α	$m\Omega$	pcs./MOQ
V _{R,70} ° _C	= 450 V DC, V _{op,85} °c	₀ = 45	0 V DC				
75	$30.0\times45.0\times57.5$	20.3	B32778G4756+000	16.0	15.5	5.5	280
80	$30.0\times45.0\times57.5$	20.3	B32778G4806+000	16.5	16.0	5.0	280
100	$35.0 \times 50.0 \times 57.5$	20.3	B32778G4107+000	18.0	18.0	4.0	108
110	$35.0\times50.0\times57.5$	20.3	B32778G4117+000	19.0	19.0	4.0	108
V _{R,70} ° _C	= 575 V DC, V _{op,85} °(₀ = 50	0 V DC				
60	$30.0\times45.0\times57.5$	20.3	B32778G5606+000	16.0	15.5	3.5	280
80	$35.0\times50.0\times57.5$	20.3	B32778G5806+000	19.0	18.5	3.0	108
V _{R,70} °C	= 800 V DC, V _{op,85} °c	₀ = 70	0 V DC				
45	$30.0\times45.0\times57.5$	20.3	B32778G8456+000	16.0	15.0	4.0	280
55	$35.0\times50.0\times57.5$	20.3	B32778G8556+000	17.0	16.0	3.5	108
60	$35.0\times50.0\times57.5$	20.3	B32778G8606+000	19.0	18.0	3.0	108
V _{R,70} °C	= 900 V DC, V _{op,85} °c	c = 80	0 V DC				
35	$30.0\times45.0\times57.5$	20.3	B32778G9356+000	14.0	14.0	4.5	280
50	$35.0\times50.0\times57.5$	20.3	B32778G9506K000	18.0	18.0	3.5	108
V _{R,70} ° _C	= 1100 V DC, V _{op,85} °(₀ = 92	0 V DC				
30	$30.0\times45.0\times57.5$	20.3	B32778G0306+000	16.0	14.0	5.0	280
40	$35.0\times50.0\times57.5$	20.3	B32778G0406+000	20.0	20.0	3.5	108
V _{R,70} °C	= 1300 V DC, V _{op,85} °c	c = 110	0 V DC				
20	$30.0\times45.0\times57.5$	20.3	B32778G1206+000	14.0	13.0	5.5	280
25	$35.0\times50.0\times57.5$	20.3	B32778G1256+000	17.0	16.0	4.5	108
27	$35.0 \times 50.0 \times 57.5$	20.3	B32778G1276+000	17.5	16.0	4.5	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$





MKP DC link - high density series

Technical data

Reference standard: IEC 61071. All data given at T = 20 °C, unless otherwise specified.

		_		,			
Operating temperate	ure range (case)	Max. c	perating	temperatı	ıre, T _{op,m}	_{ax} +105 °	Č
				temperat		+85 °	C
				temperat	ure T _{min}	-40 °	C
ESR (at 10 kHz)	LS 27.5	< 3.0 ·	ESR _{typ}				
	LS 37.5	< 2.5 ·	ESR_{typ}				
	LS 52.5	< 2.0 ·	ESR_{typ}				
Insulation Resistance	ce R _{ins}	30 000) s				
given as time consta	ant						
$\tau = C_R \cdot R_{ins}$, rel. hur	midity ≤ 65%						
(minimum as-delive	red values)						
DC test voltage bety	ween terminals (10 s)	1.5 · V	r _R				
DC test voltage tern	ninal to case (10 s)	2110 \	/ AC, 50 I	Hz			
Maximum peak curr	ent (A)	I _{P,max} :	$= C_R \cdot \frac{dV}{dt}$				
Damp heat test		56 day	/s/40 °C/9	3% relati	ve humic	dity	
Limit values after da	imp heat test	Capac	itance ch	ange I ∆C	C I	≤ 5%	
		Dissipa	ation facto	or change	$\Delta \tan \delta$	≤ 1.5 ⋅ 10	-3 (at 1 kHz)
		Insulat	ion resist	ance R _{ins}		\geq 50% of	minimum
						as-deliver	ed values
Reliability:	Failure rate λ	50 fit (:	≤ 1 · 10 ⁻⁹ /	h) at 0.5	· V _R , 40	°C	
	Service life t _{SL}	100 00	00 h at V _R	and 70 $^{\circ}$	C		
		For co	nversion	to other o	perating	conditions	, refer to
		chapte	r "Quality	, 2 Reliat	ility".		
V _R (V DC)		450	575	800	900	1100	1300
Continuous operation	on voltage						
V_{op} (V DC) at 70 °C		450	575	800	900	1100	1300
Continuous operation	on voltage						
V _{op} (V DC) at 85 °C		450	500	700	800	920	1100
For temperatures be	etween			ng respec	- 1	′0 °C	
70 °C and 85 °C	70 °C and 85 °C		rating at 4	450 V DC	series)		



MKP DC link - high density series



Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

Lead spacing	27.5 mm			37.5 mm						
Туре	B32774			B32776						
V _R (V DC)	450	800	1100	1300	450	575	800	900	1100	1300
dV/dt in V/μs	30	40	75	100	21	22	22	32	54	73

Lead spacing	52.5 mm						
Туре	B32778						
V _R (V DC)	450	575	800	900	1100	1300	
dV/dt in V/μs	14	15	15	25	35	50	



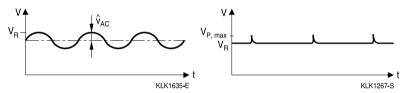


MKP DC link - high density series

ESL values

		ESL
2-pin	B32774D	25 nH
	B32776E	10 nH
4-pin	B32776G	15 nH
	B32778G	15 nH

Typical waveforms



Restrictions:

 V_R : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

 $\hat{\textbf{v}}_{\text{AC}}\!\leq \textbf{0.2}\,\cdot\,\textbf{V}_{\text{R}}$

V_{P.max}: Maximum permissible recurrent voltage that may appear for 2% of the period.



MKP DC link - high density series



Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

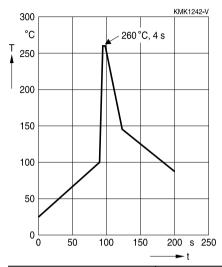
1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

Series	S	Solder bath temperature	Soldering time
MKT	boxed (except 2.5 \times 6.5 \times 7.2 mm)	260 ±5 °C	10 ±1 s
	coated		
	uncoated (lead spacing > 10 mm)		
MFP			
MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤ 7.5 mm)		< 4 s
MKT	uncoated (lead spacing ≤ 10 mm)		recommended soldering
	insulated (B32559)		profile for MKT uncoated
			(lead spacing ≤ 10 mm) and
			insulated (B32559)







Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 \pm 0.5) mm thick, between capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors	
$tan \delta$	As specified in sectional specification	



MKP DC link - high density series



1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering





MKP DC link - high density series

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	





Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"





MKP DC link - high density series

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
$lpha_{ extsf{C}}$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative	Relative Kapazitätsänderung (relative
	deviation of actual value)	Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change	Absolute Temperaturänderung
	(self-heating)	(Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate	Differentielle Spannungsänderung
	of voltage rise)	(Spannungsflankensteilheit)
ΔV/Δt	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible	Grenzfrequenz für thermisch bedingte
	AC voltage due to thermal limits	Reduzierung der zulässigen
	Fragues Visit for radicing permissible	Wechselspannung
f ₂	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen
	Ao voltage due to current innit	Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur
. ט		Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
İz	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation	Dielektrischer Anteil des Verlustfaktors
tan δ⊳	factor Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T ₄	Ambient temperature	Umgebungstemperatur
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{oL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
-OL	and voltage	-spannung
Top	Operating temperature	Beriebstemperatur
T _B	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer
V _{AC}	AC voltage	Wechselspannung





Symbol	English	German
V _c	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{o}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
ν̂ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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The following applies to all products named in this publication:

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